

# 2N4400\_D81Z Datasheet



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DiGi Electronics Part Number 2N4400\_D81Z-DG

Manufacturer onsemi

Manufacturer Product Number 2N4400\_D81Z

Description TRANS NPN 40V 0.6A TO92-3

Detailed Description Bipolar (BJT) Transistor NPN 40 V 600 mA 625 mW T

hrough Hole TO-92-3



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### **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
2N4400_D81Z	onsemi
Series:	Product Status:
	Obsolete
Transistor Type:	Current - Collector (Ic) (Max):
NPN	600 mA
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, lc:
40 V	750mV @ 50mA, 500mA
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ lc, Vce:
	50 @ 150mA, 1V
Power - Max:	Frequency - Transition:
625 mW	
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Package / Case:	Supplier Device Package:
TO-226-3, TO-92-3 (TO-226AA)	TO-92-3
Base Product Number:	
2N4400	

### **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8541.21.0095



### 2N4400

### **MMBT4400**





### **NPN General Purpose Amplifier**

This device is designed for use as general purpose amplifiers and switches requiring collector currents to 500 mA.

### **Absolute Maximum Ratings\***

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	40	V
V <sub>CBO</sub>	Collector-Base Voltage	60	V
V <sub>EBO</sub>	Emitter-Base Voltage	6.0	V
I <sub>C</sub>	Collector Current - Continuous	600	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### **Thermal Characteristics**

TA = 25°C unless otherwise noted

Symbol	Characteristic Max		Units	
		2N4400	*MMBT4400	
$P_D$	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	mW mW/∘C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

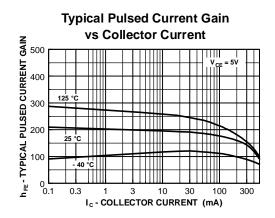
# NPN General Purpose Amplifier (continued)

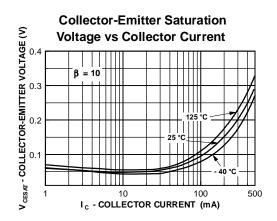
Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	ARACTERISTICS				
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	$I_C = 1.0 \text{ mA}, I_B = 0$	40		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 100 \ \mu A, \ I_E = 0$	60		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = 100 \ \mu\text{A}, \ I_C = 0$	6.0		V
I <sub>CEX</sub>	Collector Cutoff Current	$V_{CE} = 35 \text{ V}, \ V_{EB} = 0.4 \text{ V}$		0.1	μΑ
I <sub>BL</sub>	Emitter Cutoff Current	$V_{CE} = 35 \text{ V}, \ V_{EB} = 0.4 \text{ V}$		0.1	μΑ
ON CHAF	RACTERISTICS*				
h <sub>FE</sub>	DC Current Gain	$V_{CE} = 1.0 \text{ V}, I_{C} = 1.0 \text{ mA}$	20		
		$V_{CE} = 1.0 \text{ V}, I_{C} = 10 \text{ mA}$	40		
		$V_{CE} = 1.0 \text{ V}, I_{C} = 150 \text{ mA}$	50	150	
\ /	Collector Emitter Saturation Voltage	$V_{CE} = 2.0 \text{ V}, I_{C} = 500 \text{ mA}$ $I_{C} = 150 \text{ mA}, I_{B} = 15 \text{ mA}$	20	0.40	V
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.40	V
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 150 mA, I <sub>B</sub> =15 mA	0.75	0.95	V
DE(GUI)		I 500 A I 50 A			
		$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		1.2	V
		I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA		1.2	V
SMALL S	SIGNAL CHARACTERISTICS	I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA		1.2	V
	SIGNAL CHARACTERISTICS Output Capacitance	$V_{CB} = 5.0 \text{ V}, f = 140 \text{ kHz}$		6.5	V pF
SMALL S C <sub>ob</sub> C <sub>ib</sub>					
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = 5.0 V, f = 140 kHz	2.0	6.5	pF
C <sub>ob</sub> C <sub>ib</sub>	Output Capacitance Input Capacitance	$V_{CB} = 5.0 \text{ V}, f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA}, V_{CE} = 10 \text{ V},$	2.0	6.5	pF
C <sub>ob</sub> C <sub>ib</sub> h <sub>fe</sub>	Output Capacitance Input Capacitance Small-Signal Current Gain	$V_{CB} = 5.0 \text{ V}, f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA}, V_{CE} = 10 \text{ V},$ $f = 100 \text{ MHz}$		6.5	pF
C <sub>ob</sub> C <sub>ib</sub> h <sub>fe</sub> h <sub>fe</sub>	Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain	$V_{CB} = 5.0 \text{ V, } f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V, } f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA, } V_{CE} = 10 \text{ V, }$ $f = 100 \text{ MHz}$ $V_{CE} = 10 \text{ V, } I_{C} = 1.0 \text{ mA, }$	20	6.5 30 250	pF pF
C <sub>ob</sub> C <sub>ib</sub> h <sub>fe</sub> h <sub>ie</sub> h <sub>re</sub>	Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance	$V_{CB} = 5.0 \text{ V, } f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V, } f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA, } V_{CE} = 10 \text{ V, }$ $f = 100 \text{ MHz}$ $V_{CE} = 10 \text{ V, } I_{C} = 1.0 \text{ mA, }$	20	6.5 30 250 7.5	pF pF
C <sub>ob</sub>	Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio	$V_{CB} = 5.0 \text{ V, } f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V, } f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA, } V_{CE} = 10 \text{ V, }$ $f = 100 \text{ MHz}$ $V_{CE} = 10 \text{ V, } I_{C} = 1.0 \text{ mA, }$	20 0.5 0.1	6.5 30 250 7.5 8.0	pF pF ΚΩ x 10 <sup>-4</sup>
C <sub>ob</sub> C <sub>ib</sub> h <sub>fe</sub> h <sub>fe</sub> h <sub>ie</sub> h <sub>re</sub> h <sub>oe</sub>	Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio	$V_{CB} = 5.0 \text{ V, } f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V, } f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA, } V_{CE} = 10 \text{ V, }$ $f = 100 \text{ MHz}$ $V_{CE} = 10 \text{ V, } I_{C} = 1.0 \text{ mA, }$	20 0.5 0.1	6.5 30 250 7.5 8.0	pF pF ΚΩ x 10 <sup>-4</sup>
Cob Cib hfe hfe hie hnoe	Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio Output Admittance	$V_{CB} = 5.0 \text{ V, } f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V, } f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA, } V_{CE} = 10 \text{ V, }$ $f = 100 \text{ MHz}$ $V_{CE} = 10 \text{ V, } I_{C} = 1.0 \text{ mA, }$	20 0.5 0.1	6.5 30 250 7.5 8.0	pF pF ΚΩ x 10 <sup>-4</sup>
Cob Cib hfe hfe hie hoe	Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio Output Admittance	$V_{CB} = 5.0 \text{ V}, f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA}, V_{CE} = 10 \text{ V},$ $f = 100 \text{ MHz}$ $V_{CE} = 10 \text{ V}, I_{C} = 1.0 \text{ mA},$ $f = 1.0 \text{ kHz}$	20 0.5 0.1	6.5 30 250 7.5 8.0 30	pF pF KΩ x 10 <sup>-4</sup> μmhos
C <sub>ob</sub> C <sub>ib</sub> h <sub>fe</sub> h <sub>fe</sub> h <sub>ie</sub> h <sub>re</sub> h <sub>oe</sub>	Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio Output Admittance  ING CHARACTERISTICS Delay Time	$V_{CB} = 5.0 \text{ V}, f = 140 \text{ kHz}$ $V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz}$ $I_{C} = 20 \text{ mA}, V_{CE} = 10 \text{ V},$ $f = 100 \text{ MHz}$ $V_{CE} = 10 \text{ V}, I_{C} = 1.0 \text{ mA},$ $f = 1.0 \text{ kHz}$ $V_{CC} = 30 \text{ V}, I_{C} = 150 \text{ mA},$	20 0.5 0.1	6.5 30 250 7.5 8.0 30	pF pF KΩ x 10 <sup>-4</sup> μmhos

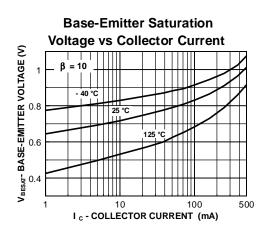
<sup>\*</sup>Pulse Test: Pulse Width £ 300 ms, Duty Cycle £ 2.0%

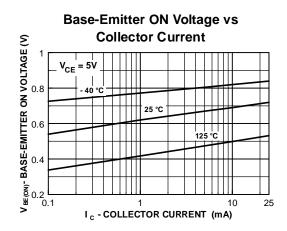
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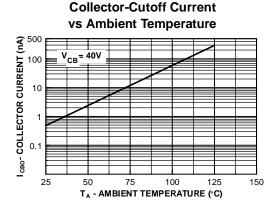
### **Typical Characteristics**

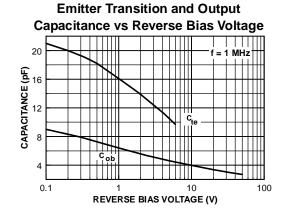








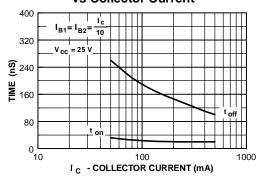




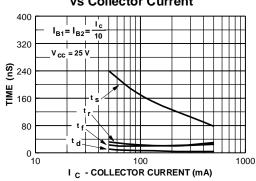
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### Typical Characteristics (continued)

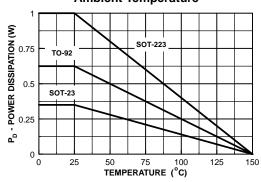
### Turn On and Turn Off Times vs Collector Current



## Switching Times vs Collector Current

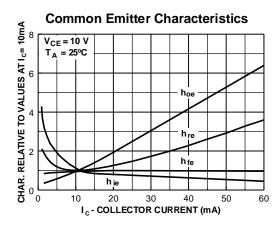


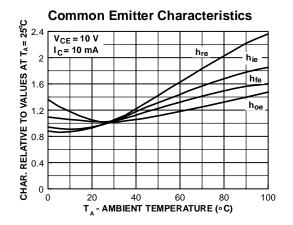
### Power Dissipation vs Ambient Temperature

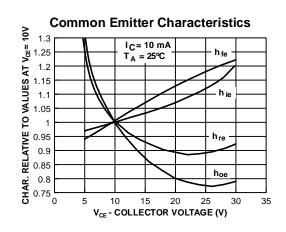


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### **Typical Common Emitter Characteristics** (f = 1.0kHz)







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### **Test Circuits**

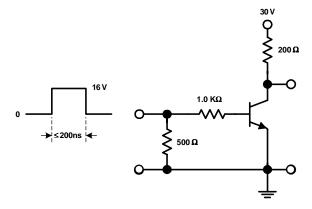


FIGURE 1: Saturated Turn-On Switching Timer

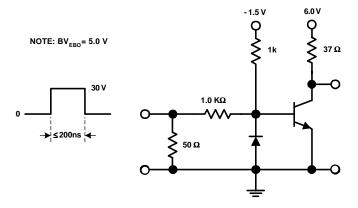


FIGURE 2: Saturated Turn-Off Switching Time

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DOME™ Quiet Series™ ISOPLANAR™

E<sup>2</sup>CMOS<sup>TM</sup> MICROWIRE™ SILENT SWITCHER® EnSigna™ OPTOLOGIC™ SMART START™ FACT™ OPTOPLANAR™ SuperSOT™-3 FACT Quiet Series™ PACMAN™ SuperSOT™-6 **POPTM** SuperSOT™-8 FAST®

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